

## Matching MOSFET Drivers to MOSFETs

### INTRODUCTION

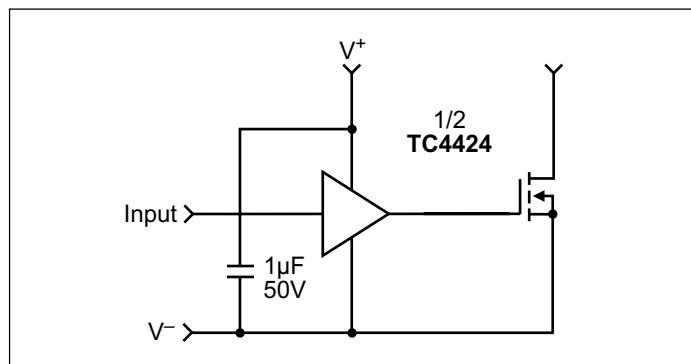
Microchip offers many sizes of MOSFET drivers. This allows the designer to best match the switching performance of the driver/ MOSFET to the application.

### MOSFET DIE SIZES

Unlike bipolar transistors in which die size is primarily a function of current, MOSFETs have die sizes that are a function of both current and voltage.

### DIE SIZE EFFECT ON GATE CAPACITANCE

As can be expected, the larger the die size, the larger the effective gate capacitance. As an illustration of this, look through any manufacturer's databook and relate die size to  $C_{GS}$  and  $C_{RSS}$  and you will find that die size determines both these parameters, not the voltage or current rating of the device.

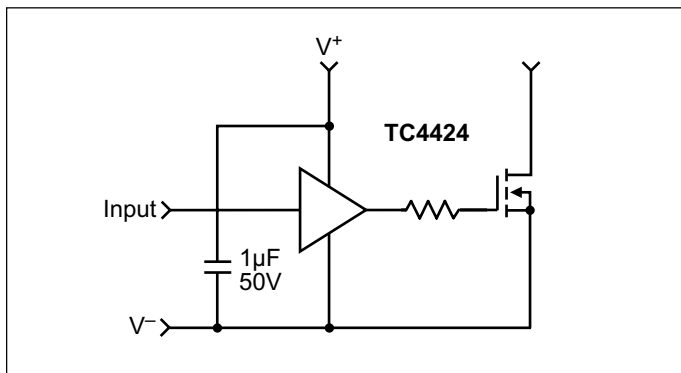


**FIGURE 1:** Typical drive circuit.

The industry has, in general, adopted International Rectifier's die size description technique. Instead of referring to "mils on a side" to describe the die size, they have used simple numeric indicators 0 through 6. Thus, a Hex 0 is the smallest die, while a Hex 6 is the largest in standard MOSFET offerings. Some other manufacturers (IXYS) are offering sizes as large as Hex 9. Parallel-MOSFET modules can be even larger.

### PEAK CURRENT REQUIREMENTS

One can now view the driving function in terms of the peak current required to obtain the required rise time for any application (in view of the capacitance thus die size). From  $[(dV) \times C]/I = dT$  we can determine the trade-offs in any driving circuit. The optimum rise time in any application is based on many requirements, such as EMI, heat dissipation, lead/circuit inductance, etc. Thus, there can be no universal driver that fits all applications.



**FIGURE 2:** Use of a resistor to limit peak control.

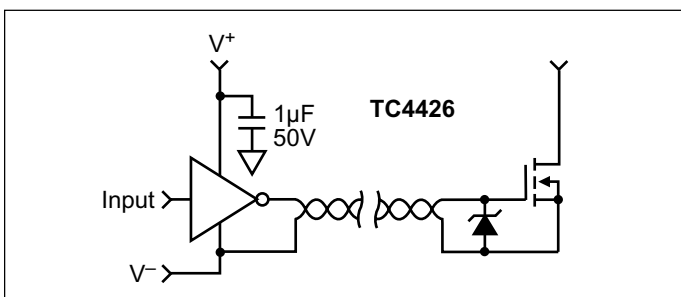
### DRIVER FAMILIES

There are several families of Microchip MOSFET drivers. They are:

TC426-29  
TC1410-13  
TC1426-28  
TC4403-05  
TC4420-29  
TC4431/32  
TC4467-69  
TC4626/27

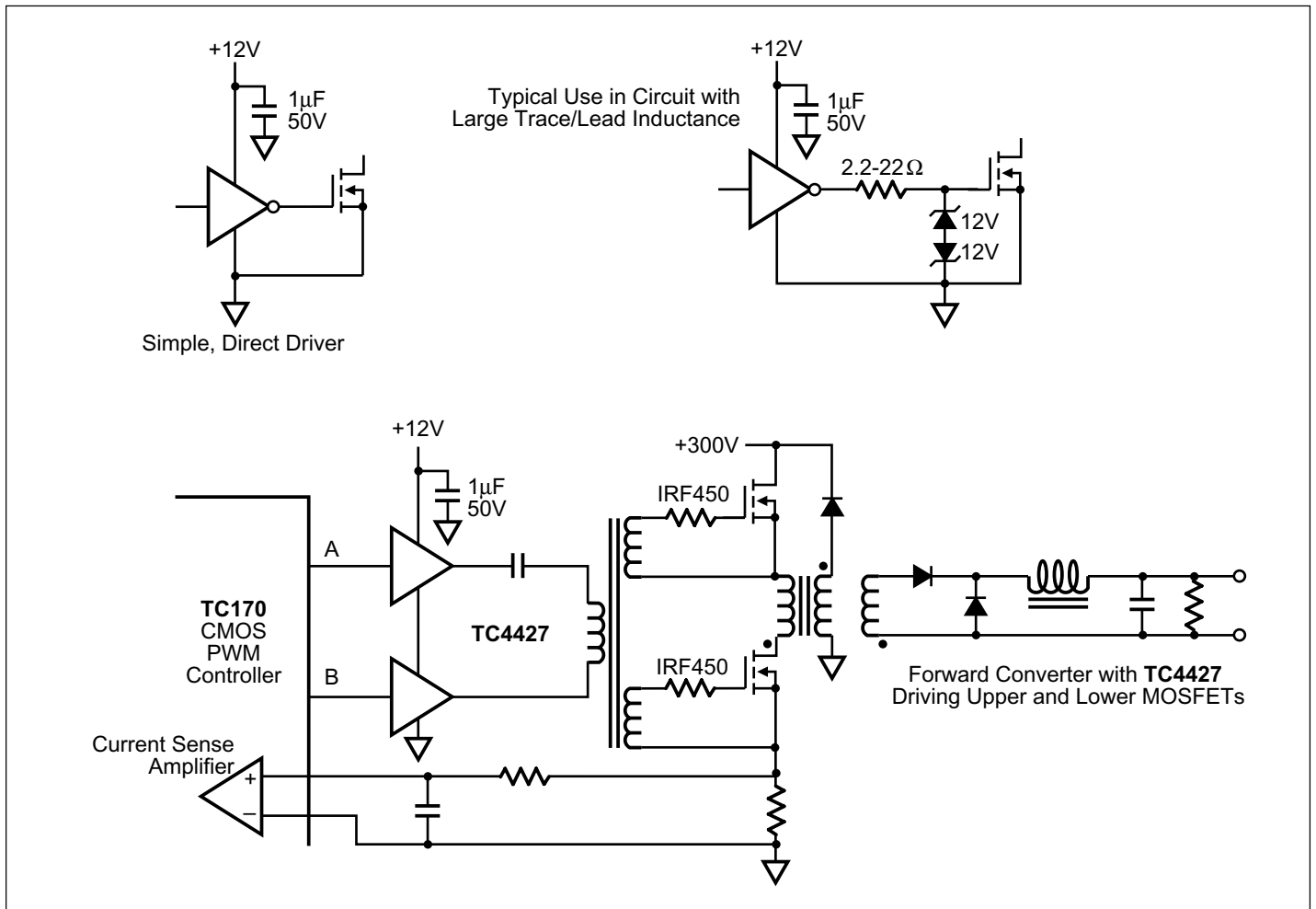
The TC426 was the world's first CMOS MOSFET driver. It was a dual output device capable of up to 1.5A at 18V. It came in two other versions, the dual non-inverting TC427 driver, and one inverting plus one non-inverting in the TC428 driver.

The TC4426 family is the second generation of the 426 family, but through improved processing and design has less propagation delay, and draws half the power of the first generation. These improvements have been incorporated into all drivers with four numeric digits in the part number.



**FIGURE 3:** Use of zener diode to clamp voltage on long output lines.

# AN30



**FIGURE 4:** Typical applications.

Another important improvement in the second generation families is their ability to have the input signal go below the negative rail by as much as 5V. This guaranteed parameter is very useful in systems where the control circuit ground is not closely tied to the power or source ground of the MOSFET. These two grounds often move relative to one another.

The TC1426 is a special, low-cost version of the 426 family that does not have the below-rail protection on the input. It is a good choice for large volume OEMs.

Following the same part numbering pattern as the 1.5A TC426 family, the TC4423 family of dual drivers has a 3A output capacity. The TC4424 is a dual non-inverting driver and the TC4425 is one inverting plus one non-inverting driver.

The TC4429 is a single inverting driver (like its predecessor the TC429), while the TC4420 is non-inverting. This family has a 6A drive capability at 18V. The TC4429 can slew a 10,000pF load at 18V in 65nsec typically.

The table on the following page shows the performance of the various drivers under production test methods. The characteristics of the drivers are more fully described in their individual data sheets. This table is intended only as a guide for comparing specifications. Refer to the individual data sheets for more complete information.

The following families of power drivers are made with a CMOS process to interface between low-level control functions and high-power switching devices, particularly power MOSFETs. The devices are also an optimum choice for capacitive drivers where 1.2A–9A may be switched. With both inverting and non-inverting outputs available, logic signals of either polarity may be accepted.

Device No.	Drive Current (Peak)	Number of Outputs and Type		Time @ Rated Load (pF)	Rise Time @ Rated Load (nsec)	Fall Edge Rated Load (nsec)	Rising Edge Prop. Delay (nsec)	Falling Edge Prop. Delay (nsec)	Latch-Up Proof	Input Protected to 5V Below Gnd Rail
		Inverting	Non-Invert.							
TC1426	1.2A	Dual		1000	35	25	75	75	Yes	No
TC1427	1.2A	Dual		1000	35	25	75	75	Yes	No
TC1428	1.2A	Single	Single	1000	35	25	75	75	Yes	No
TC4426	1.5A	Dual		1000	19	19	20	40	Yes	Yes
TC4427	1.5A	Dual		1000	19	19	20	40	Yes	Yes
TC4428	1.5A	Single	Single	1000	19	19	20	40	Yes	Yes
TC4423	3.0A	Dual		1800	23	25	33	38	Yes	Yes
TC4424	3.0A	Dual		1800	23	25	33	38	Yes	Yes
TC4425	3.0A	Single	Single	1800	23	25	33	38	Yes	Yes
TC4420	6.0A	Single		2500	25	25	55	55	Yes	Yes
TC4429	6.0A	Single		2500	25	25	55	55	Yes	Yes
TC4421	9.0A	Single		10,000	60	60	30	33	Yes	Yes
TC4422	9.0A	Single		10,000	60	60	30	33	Yes	Yes
TC4467	1.2A	— Quad NAND —		470	15	15	40	40	Yes	Yes
TC4468	1.2A	— Quad AND —		470	15	15	40	40	Yes	Yes
TC4469	1.2A	— Quad —		470	15	15	40	40	Yes	Yes

TABLE 1: Selecting MOSFET drivers.

MOSFET Size	Die Size (mm)	Total C of MOSFET (pF)	Suggested MOSFET Driver (@ 12V)	Faster Rise/Fall Times
Hex 0	0.89 x 1.09	400	TC1426-28/4426-28/4467-69	
Hex 1	1.75 x 2.41	750	TC1426-28/4426-28/4467-69	
Hex 2	3.40 x 2.21	1500	TC1426-28/4426-28/4467-69	TC4423-25
Hex 3	4.44 x 2.79	3000	TC1426-28/4426-28	TC4423-25
Hex 4	7.04 x 4.32	6000	TC4423-25	TC4420/29
Hex 5	6.45 x 6.45	12,000	TC4423-25	TC4420/29
Hex 6	283 x 321 mil	15,000	TC4420/29	TC4421/22
Hex 7	283 x 348 mil	16,000	TC4420/29	TC4421/22
Parallel Modules	Various	Up to 48,000	TC4421/22	

TABLE 2: MOSFET die size suggested driver families.

## CONCLUSIONS

To match any MOSFET to its proper driver, use the chart above (which will take care of the largest number of applications), or use the simple formula: rise time (dt) = driver supply voltage (dV), times capacitance (C), all divided by driver peak current (I); restated:

$$dt = [(dV) \times C] / I$$

If you need to drive any power MOSFET, there is a Microchip driver to do the job.

Information contained in this publication regarding device applications and the like is intended through suggestion only and may be superseded by updates. It is your responsibility to ensure that your application meets with your specifications. No representation or warranty is given and no liability is assumed by Microchip Technology Incorporated with respect to the accuracy or use of such information, or infringement of patents or other intellectual property rights arising from such use or otherwise. Use of Microchip's products as critical components in life support systems is not authorized except with express written approval by Microchip. No licenses are conveyed, implicitly or otherwise, under any intellectual property rights.

## Trademarks

The Microchip name and logo, the Microchip logo, PIC, PICmicro, PICMASTER, PICSTART, PRO MATE, KEELOQ, SEEVAL, MPLAB and The Embedded Control Solutions Company are registered trademarks of Microchip Technology Incorporated in the U.S.A. and other countries.

Total Endurance, ICSP, In-Circuit Serial Programming, Filter-Lab, MXDEV, microID, *Flex*ROM, *fuzzy*LAB, MPASM, MPLINK, MPLIB, PICC, PICDEM, PICDEM.net, ICEPIC, Migratable Memory, FanSense, ECONOMONITOR, Select Mode and microPort are trademarks of Microchip Technology Incorporated in the U.S.A.

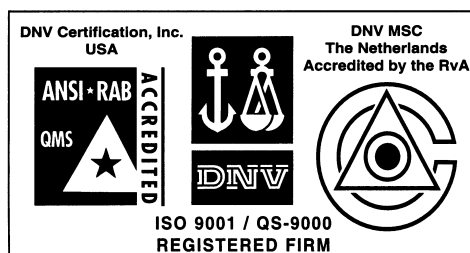
Serialized Quick Term Programming (SQTP) is a service mark of Microchip Technology Incorporated in the U.S.A.

All other trademarks mentioned herein are property of their respective companies.

© 2001, Microchip Technology Incorporated, Printed in the U.S.A., All Rights Reserved.



Printed on recycled paper.



*Microchip received QS-9000 quality system certification for its worldwide headquarters, design and wafer fabrication facilities in Chandler and Tempe, Arizona in July 1999. The Company's quality system processes and procedures are QS-9000 compliant for its PICmicro® 8-bit MCUs, KEELOQ® code hopping devices, Serial EEPROMs and microperipheral products. In addition, Microchip's quality system for the design and manufacture of development systems is ISO 9001 certified.*



## WORLDWIDE SALES AND SERVICE

### AMERICAS

#### Corporate Office

2355 West Chandler Blvd.  
Chandler, AZ 85224-6199  
Tel: 480-792-7200 Fax: 480-792-7277  
Technical Support: 480-792-7627  
Web Address: <http://www.microchip.com>

#### Rocky Mountain

2355 West Chandler Blvd.  
Chandler, AZ 85224-6199  
Tel: 480-792-7966 Fax: 480-792-7456

#### Atlanta

500 Sugar Mill Road, Suite 200B  
Atlanta, GA 30350  
Tel: 770-640-0034 Fax: 770-640-0307

#### Austin - Analog

13740 North Highway 183  
Building J, Suite 4  
Austin, TX 78750  
Tel: 512-257-3370 Fax: 512-257-8526

#### Boston

2 Lan Drive, Suite 120  
Westford, MA 01886  
Tel: 978-692-3848 Fax: 978-692-3821

#### Boston - Analog

Unit A-8-1 Millbrook Tarry Condominium  
97 Lowell Road  
Concord, MA 01742  
Tel: 978-371-6400 Fax: 978-371-0050

#### Chicago

333 Pierce Road, Suite 180  
Itasca, IL 60143  
Tel: 630-285-0071 Fax: 630-285-0075

#### Dallas

4570 Westgrove Drive, Suite 160  
Addison, TX 75001  
Tel: 972-818-7423 Fax: 972-818-2924

#### Dayton

Two Prestige Place, Suite 130  
Miamisburg, OH 45342  
Tel: 937-291-1654 Fax: 937-291-9175

#### Detroit

Tri-Atria Office Building  
32255 Northwestern Highway, Suite 190  
Farmington Hills, MI 48334  
Tel: 248-538-2250 Fax: 248-538-2260

#### Los Angeles

18201 Von Karman, Suite 1090  
Irvine, CA 92612  
Tel: 949-263-1888 Fax: 949-263-1338

#### New York

150 Motor Parkway, Suite 202  
Hauppauge, NY 11788  
Tel: 631-273-5305 Fax: 631-273-5335

#### San Jose

Microchip Technology Inc.  
2107 North First Street, Suite 590  
San Jose, CA 95131  
Tel: 408-436-7950 Fax: 408-436-7955

#### Toronto

6285 Northam Drive, Suite 108  
Mississauga, Ontario L4V 1X5, Canada  
Tel: 905-673-0699 Fax: 905-673-6509

### ASIA/PACIFIC

#### Australia

Microchip Technology Australia Pty Ltd  
Suite 22, 41 Rawson Street  
Epping 2121, NSW  
Australia  
Tel: 61-2-9868-6733 Fax: 61-2-9868-6755

#### China - Beijing

Microchip Technology Consulting (Shanghai)  
Co., Ltd., Beijing Liaison Office  
Unit 915  
Bei Hai Wan Tai Bldg.  
No. 6 Chaoyangmen Beidajie  
Beijing, 100027, No. China  
Tel: 86-10-85282100 Fax: 86-10-85282104

#### China - Chengdu

Microchip Technology Consulting (Shanghai)  
Co., Ltd., Chengdu Liaison Office  
Rm. 2401, 24th Floor,  
Ming Xing Financial Tower  
No. 88 TIDU Street  
Chengdu 610016, China  
Tel: 86-28-6766200 Fax: 86-28-6766599

#### China - Fuzhou

Microchip Technology Consulting (Shanghai)  
Co., Ltd., Fuzhou Liaison Office  
Rm. 531, North Building  
Fujian Foreign Trade Center Hotel  
73 Wusi Road  
Fuzhou 350001, China  
Tel: 86-591-7557563 Fax: 86-591-7557572

#### China - Shanghai

Microchip Technology Consulting (Shanghai)  
Co., Ltd.  
Room 701, Bldg. B  
Far East International Plaza  
No. 317 Xian Xia Road  
Shanghai, 200051  
Tel: 86-21-6275-5700 Fax: 86-21-6275-5060

#### China - Shenzhen

Microchip Technology Consulting (Shanghai)  
Co., Ltd., Shenzhen Liaison Office  
Rm. 1315, 13/F, Shenzhen Kerry Centre,  
Renminnan Lu  
Shenzhen 518001, China  
Tel: 86-755-2350361 Fax: 86-755-2366086

#### Hong Kong

Microchip Technology Hongkong Ltd.  
Unit 901-6, Tower 2, Metroplaza  
223 Hing Fong Road  
Kwai Fong, N.T., Hong Kong  
Tel: 852-2401-1200 Fax: 852-2401-3431

#### India

Microchip Technology Inc.  
India Liaison Office  
Divyasree Chambers  
1 Floor, Wing A (A3/A4)  
No. 11, O'Shaughnessey Road  
Bangalore, 560 025, India  
Tel: 91-80-2290061 Fax: 91-80-2290062

### Japan

Microchip Technology Japan K.K.  
Benex S-1 6F  
3-18-20, Shinyokohama  
Kohoku-Ku, Yokohama-shi  
Kanagawa, 222-0033, Japan  
Tel: 81-45-471-6166 Fax: 81-45-471-6122

### Korea

Microchip Technology Korea  
168-1, Youngbo Bldg. 3 Floor  
Samsung-Dong, Kangnam-Ku  
Seoul, Korea 135-882  
Tel: 82-2-554-7200 Fax: 82-2-558-5934

### Singapore

Microchip Technology Singapore Pte Ltd.  
200 Middle Road  
#07-02 Prime Centre  
Singapore, 188980  
Tel: 65-334-8870 Fax: 65-334-8850

### Taiwan

Microchip Technology Taiwan  
11F-3, No. 207  
Tung Hua North Road  
Taipei, 105, Taiwan  
Tel: 886-2-2717-7175 Fax: 886-2-2545-0139

### EUROPE

#### Denmark

Microchip Technology Denmark ApS  
Regus Business Centre  
Lautrup høj 1-3  
Ballerup DK-2750 Denmark  
Tel: 45 4420 9895 Fax: 45 4420 9910

#### France

Arizona Microchip Technology SARL  
Parc d'Activite du Moulin de Massy  
43 Rue du Saule Trapu  
Batiment A - 1er Etage  
91300 Massy, France  
Tel: 33-1-69-53-63-20 Fax: 33-1-69-30-90-79

#### Germany

Arizona Microchip Technology GmbH  
Gustav-Heinemann Ring 125  
D-81739 Munich, Germany  
Tel: 49-89-627-144 0 Fax: 49-89-627-144-44

#### Germany - Analog

Lochamer Strasse 13  
D-82152 Martinsried, Germany  
Tel: 49-89-895650-0 Fax: 49-89-895650-22

#### Italy

Arizona Microchip Technology SRL  
Centro Direzionale Colleoni  
Palazzo Taurus 1 V. Le Colleoni 1  
20041 Agrate Brianza  
Milan, Italy  
Tel: 39-039-65791-1 Fax: 39-039-6899883

#### United Kingdom

Arizona Microchip Technology Ltd.  
505 Eskdale Road  
Winnersh Triangle  
Wokingham  
Berkshire, England RG41 5TU  
Tel: 44 118 921 5869 Fax: 44-118 921-5820

08/01/01